24GHz Super Low Noise FET in Hollow Plastic PKG

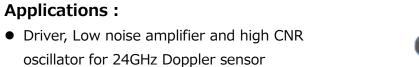


Features:

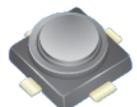
- Device for Doppler sensor applications
- Low noise figure and high associated gain

Description:

- Low Noise and High Gain
- Hollow (Air cavity) Plastic package



 Low noise amplifier for microwave communication system

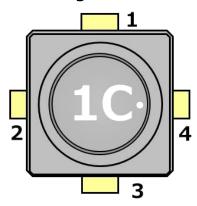


Package:

applications

Micro-X plastic package

PIN Configuration:



PIN No.	PIN Name	
1	Source	
2	Drain	
3	Source	
4	Gate	

Ordering Information:

Part Number	Order Number	Package	Marking	Supplying Form
CKRF7531CK34	CKRF7531CK34-C1	Micro-X plastic	1C	•Embossed 8 mm wide
		package		∙Pin 4 (Gate) faces the
				perforation side of the tape
				·Qty 10Kpce/reel

24GHz Super Low Noise FET in Hollow Plastic PKG



Absolute Maximum Ratings:

(TA=+25℃, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain to Source Voltage	VDS	4.0	V
Gate to Source Voltage	VGS	-3.0	V
Drain Current	ID	IDSS	mA
Gate Current	IG	80	μΑ
Total Power Dissipation	Ptot	125	mW
Channel Temperature	Tch	+150	$^{\circ}$
Storage Temperature	Tstg	-55 to +125	$^{\circ}$
Operation temperature	Тор	-55 to +125 *1	$^{\circ}$

^{*1 :} Relationship of Ambient Temperature and Total Power Dissipation, please refer to the Page 3

Recommended Operating Range:

 $(TA=+25^{\circ}C, unless otherwise specified)$

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	VDS	+1	+2	+3	V
Drain Current	ID	5	10	15	mA

Electrical Characteristics:

(TA=+25 $^{\circ}$ C, unless otherwise specified)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Gate to Source Leak Current	IGSO	VGS=-3.0V	-	0.4	10	μΑ
Saturated Drain Current	IDSS	VDS=2V, VGS=0V	23	40	57	mA
Gate to Source Cut-off Voltage	VGS(off)	VDS=2V, ID=100uA	-1.10	-0.75	-0.39	V
Transconductance	Gm	VDS=2V, ID=10mA	47	62	-	mS
Noise Figure	NF	VDS=2V, ID=10mA,	-	0.92	1.20	dB
Associated Gain	Ga	f=24GHz	10.5	11.2	-	dB

CDS-0049-03 Page 2 of 7

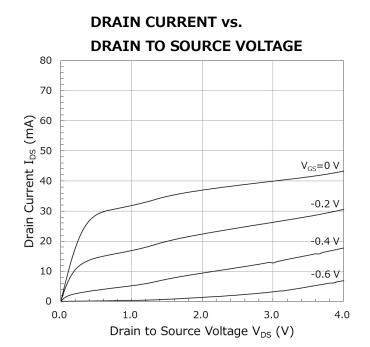
24GHz Super Low Noise FET in Hollow Plastic PKG



Typical Characteristics:

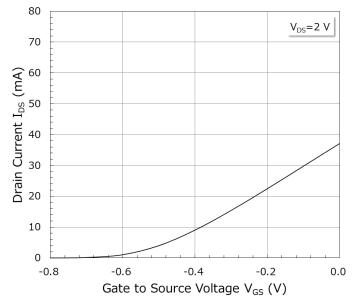
(TA=+25℃, unless otherwise specified)

TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE (Mu) LOL 150 (Mu) 50 50 100 150



DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

Ambient Temperature T_A (deg C)



CDS-0049-03 Page 3 of 7

24GHz Super Low Noise FET in Hollow Plastic PKG



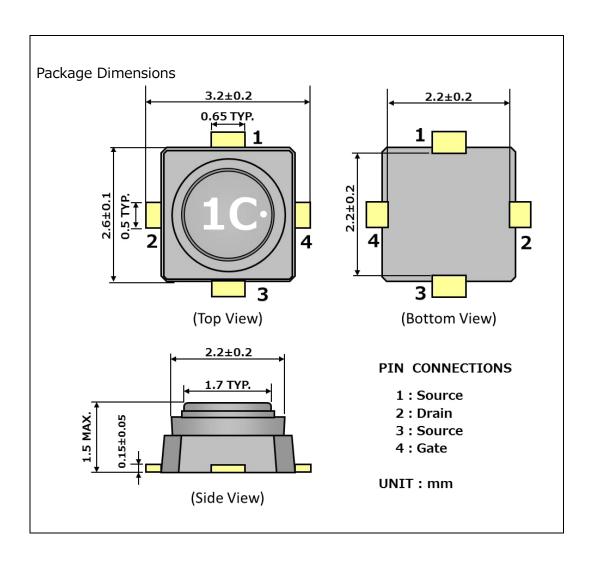
RF Measuring Layout Pattern:

RF Measuring Layout Patterns are provided on the CDK Web site.

[Original Products] \rightarrow [Low Noise GaAsFET for Doppler sensor at 24GHz] \rightarrow [Design Support] \rightarrow [Evaluation Board Information]

URL http://www.en.cdk.co.jp/products/highfrequency/rf/LNGaAsFET/Doppler/designsupport/index.html

Package Dimensions:



CDS-0049-03 Page 4 of 7

24GHz Super Low Noise FET in Hollow Plastic PKG



Recommended Soldering Conditions:

Recommended Soldering Conditions are provided on the CDK Web site.

[Original Products] \rightarrow [Low Noise GaAsFET for Doppler sensor at 24GHz] \rightarrow

[Design Support] \rightarrow [others]

URL http://www.en.cdk.co.jp/products/highfrequency/rf/LNGaAsFET/Doppler/designsupport/index.html

CDS-0049-03 Page 5 of 7





[CAUTION]

- All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice.
- · You should not alter, modify, copy, or otherwise misappropriate any CDK product, whether in whole or in part.
- CDK does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of CDK products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of CDK or others.
- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. CDK assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- CDK has used reasonable care in preparing the information included in this document, but CDK does not warrant that such information is error free. CDK assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- Although CDK endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions.
 Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a CDK product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures
 - Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
- Please use CDK products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive.
 - CDK assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of CDK.
- Please contact a CDK if you have any questions regarding the information contained in this document or CDK products, or if you have any other inquiries.

CDS-0049-03 Page 6 of 7





[Caution in the gallium arsenide (GaAs) product handling]

This product uses gallium arsenide (GaAs) of the toxic substance appointed in laws and ordinances. GaAs vapor and powder are hazardous to human health if inhaled or ingested.

- Do not dispose in fire or break up this product.
- Do not chemically make gas or powder with this product.
- When discard this product, please obey the law of your country.
- Do not lick the product or in any way allow it to enter the mouth.

[CAUTION]

Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

CHUO DENSHI KOGYO CO., LTD

3400 Kooyama, Matsubase, Uki-City,

Kumamoto, 869-0512, JAPAN

Tel : +81-964-32-2730 Fax : +81-964-32-3549

URL : http://www.en.cdk.co.jp/

Contact info for inquiries

Electronic Devices Division Sales and Planning Department

Tel : +81-964-32-2750 E-mail : info@cdk.co.jp FAX : +81-964-32-3549

CDS-0049-03 Page 7 of 7